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(12) **United States Design Patent**
Obata

(10) **Patent No.:** **US D485,548 S**

(45) **Date of Patent:** **** Jan. 20, 2004**

(54) **EARPHONE**

(75) **Inventor:** **Shinichi Obata, Tokyo (JP)**

(73) **Assignee:** **Sony Corporation, Tokyo (JP)**

(**) **Term:** **14 Years**

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(51) **LOC (7) Cl.** **14-01**

(52) **U.S. Cl.** **D14/223**

(58) **Field of Search** D14/192, 205,
D14/206, 223, 249; D24/174; 181/129,
130, 135, 137; 379/430; 381/381

(56) **References Cited**

U.S. PATENT DOCUMENTS

4,720,857	A	*	1/1988	Burris et al.	379/430
4,981,194	A	*	1/1991	Kamon et al.	181/129
5,048,092	A	*	9/1991	Yamagishi et al.	381/380 X
D337,118	S	*	7/1993	Seikita	D14/223
D337,589	S	*	7/1993	Wada	D14/223
D353,379	S	*	12/1994	Nakamura et al.	D14/223
D357,921	S	*	5/1995	Ming-Chin	D14/223
D369,349	S	*	4/1996	Hayashi	D14/223

D402,661 S * 12/1998 Hayashi D14/223

D431,553 S 10/2000 Suzuki

D463,789 S * 10/2002 DeKalb et al. D14/223

D474,171 S * 5/2003 Suzuki D14/206

OTHER PUBLICATIONS

Catalog "SONY Value up," p. 9, Sony (Jan. 2002).

* cited by examiner

Primary Examiner—Paula A. Mortimer

(74) *Attorney, Agent, or Firm*—Rader, Fishman & Grauer
PLLC

(57) **CLAIM**

The ornamental design for an earphone, as shown.

DESCRIPTION

FIG. 1 is a perspective view of an earphone showing my new design;

FIG. 2 is a front elevational view thereof;

FIG. 3 is a rear elevational view thereof;

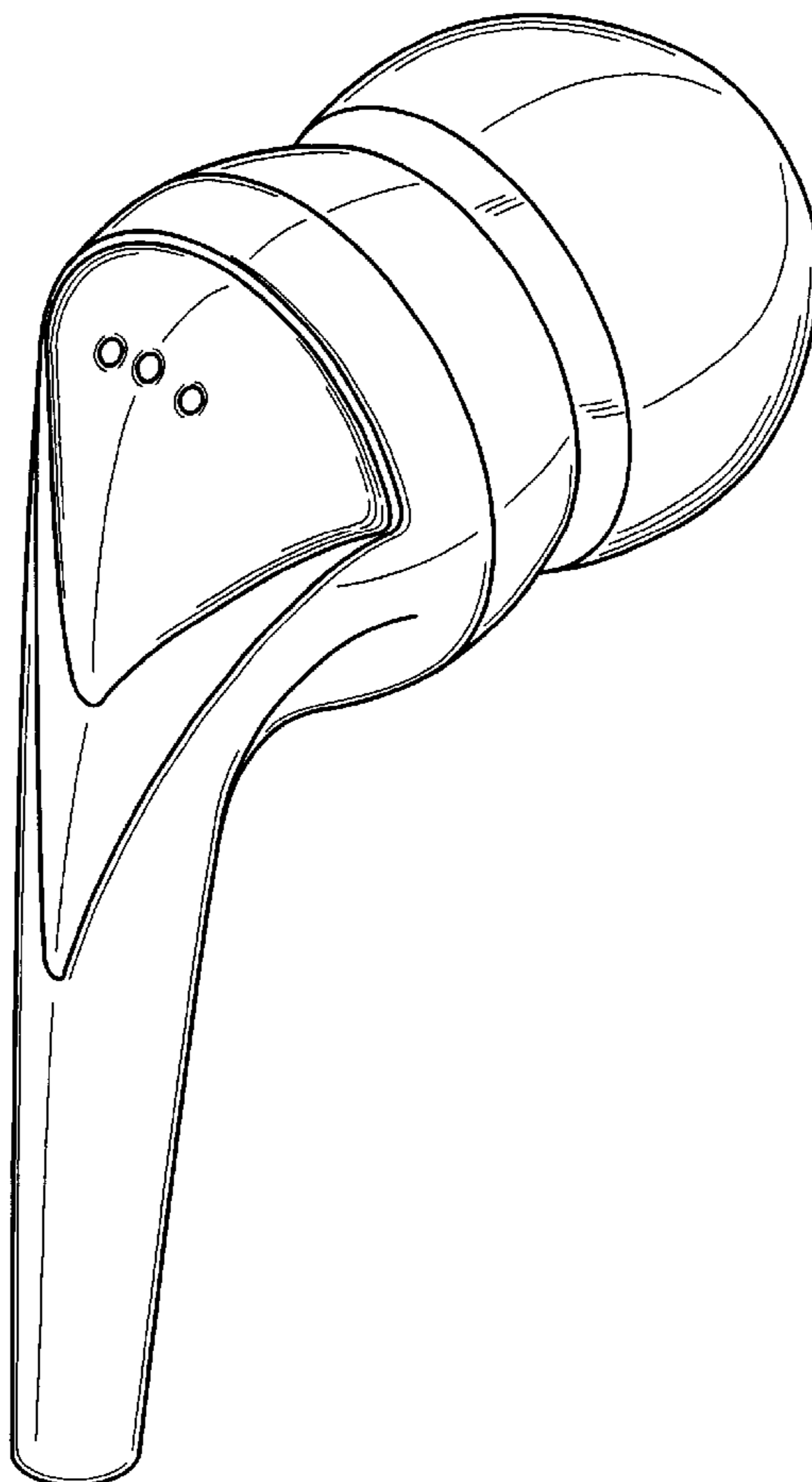
FIG. 4 is a left side elevational view thereof;

FIG. 5 is a right side elevational view thereof;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.

1 Claim, 4 Drawing Sheets



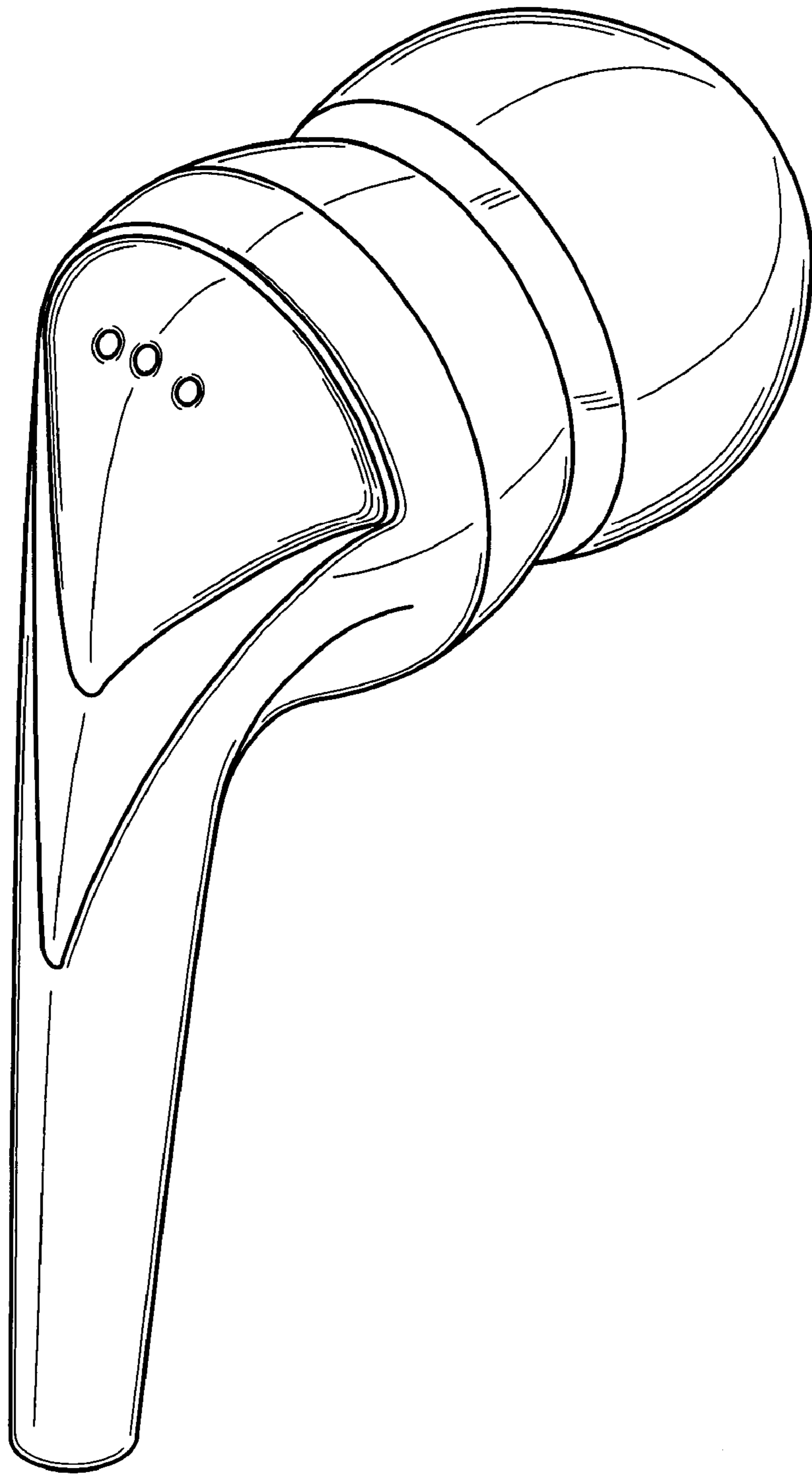


FIG. 1

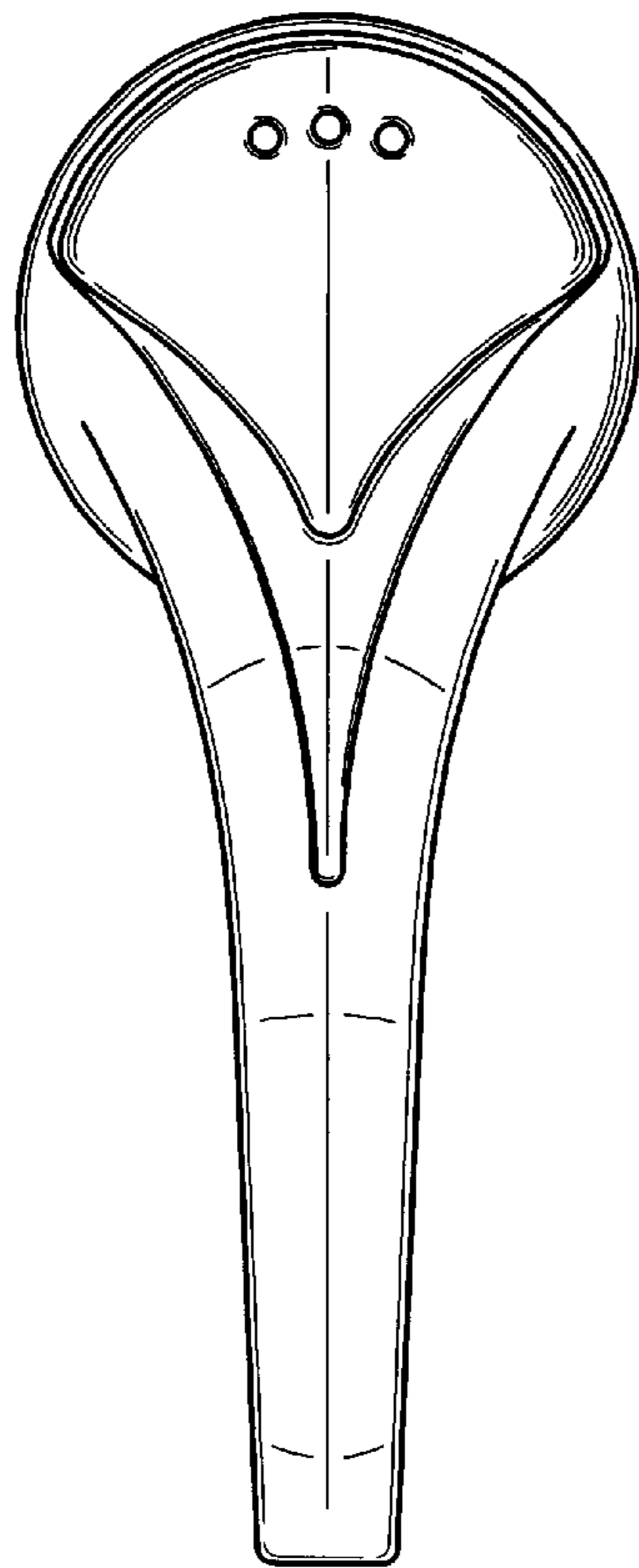


FIG. 2

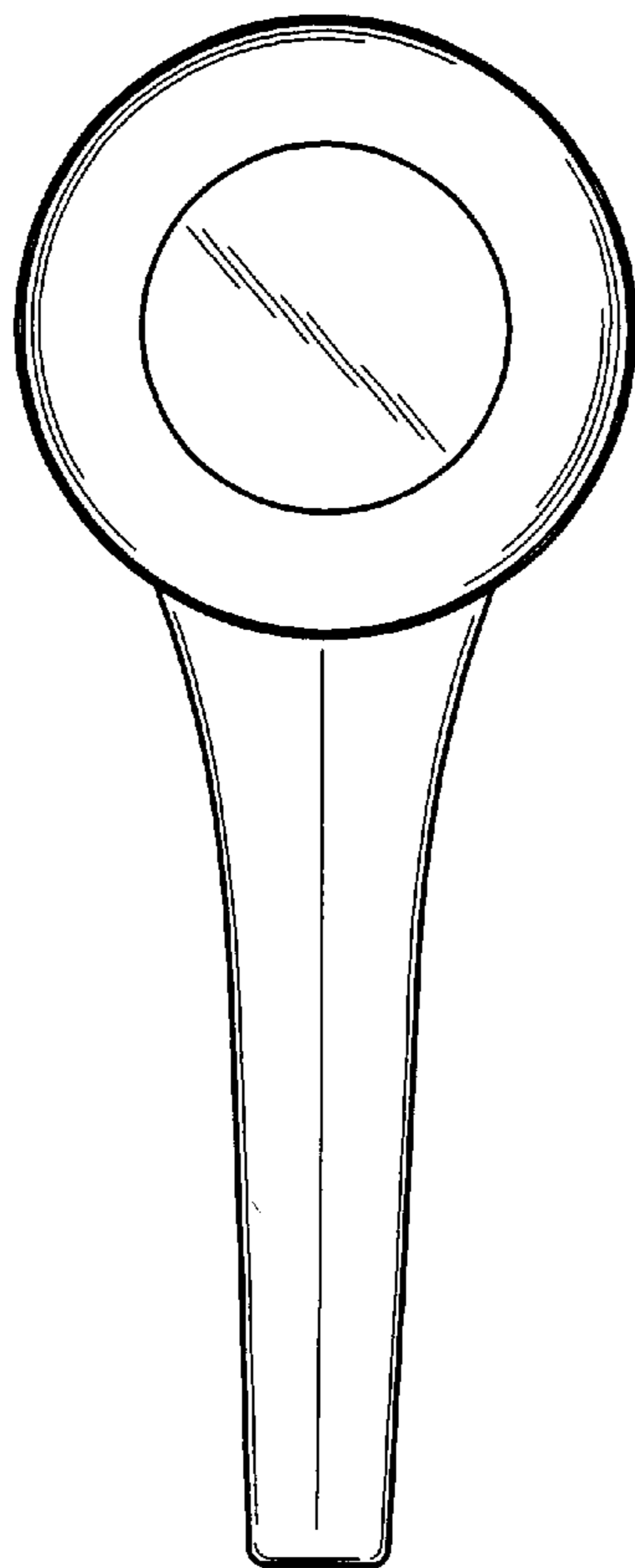


FIG. 3

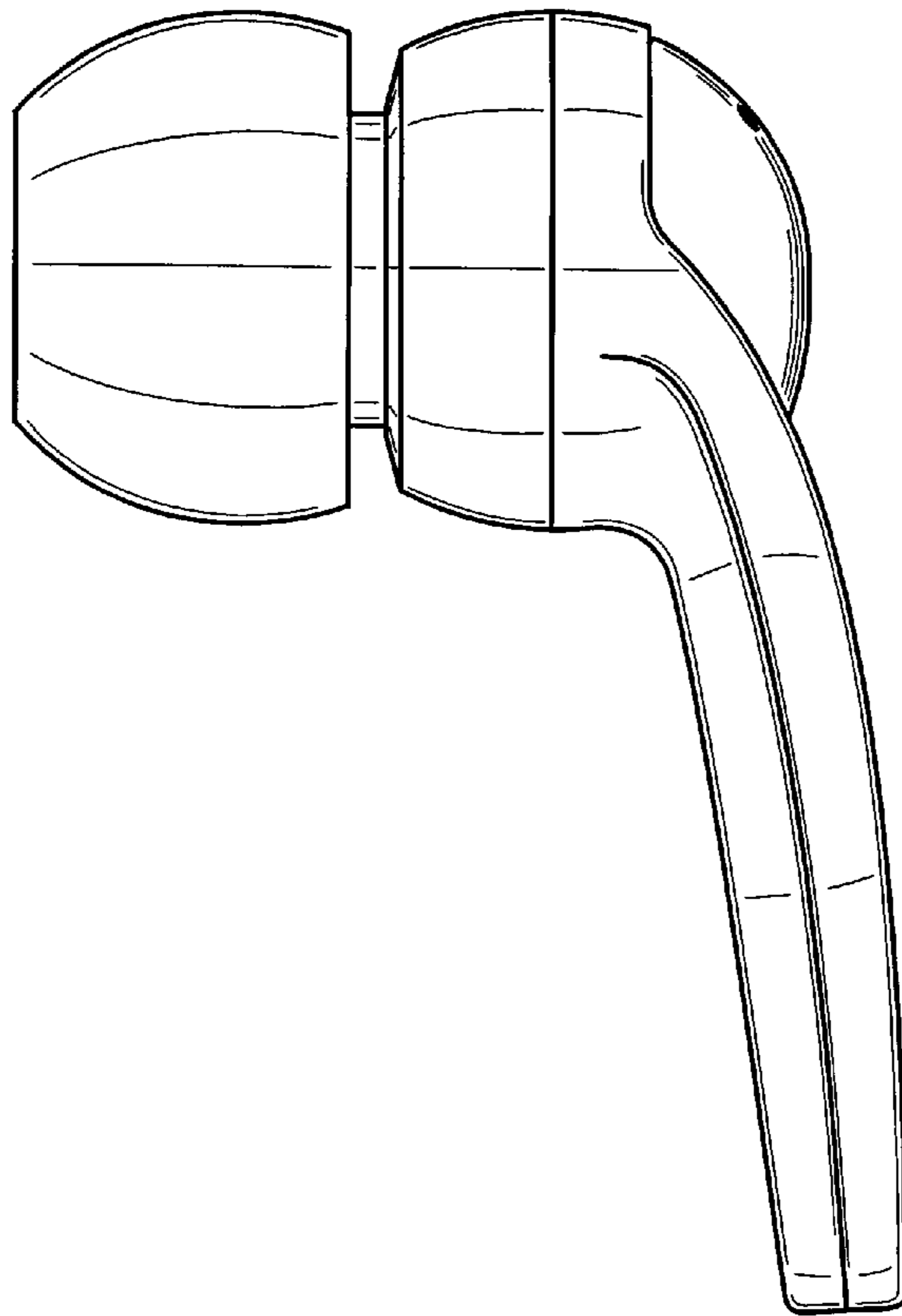


FIG. 4

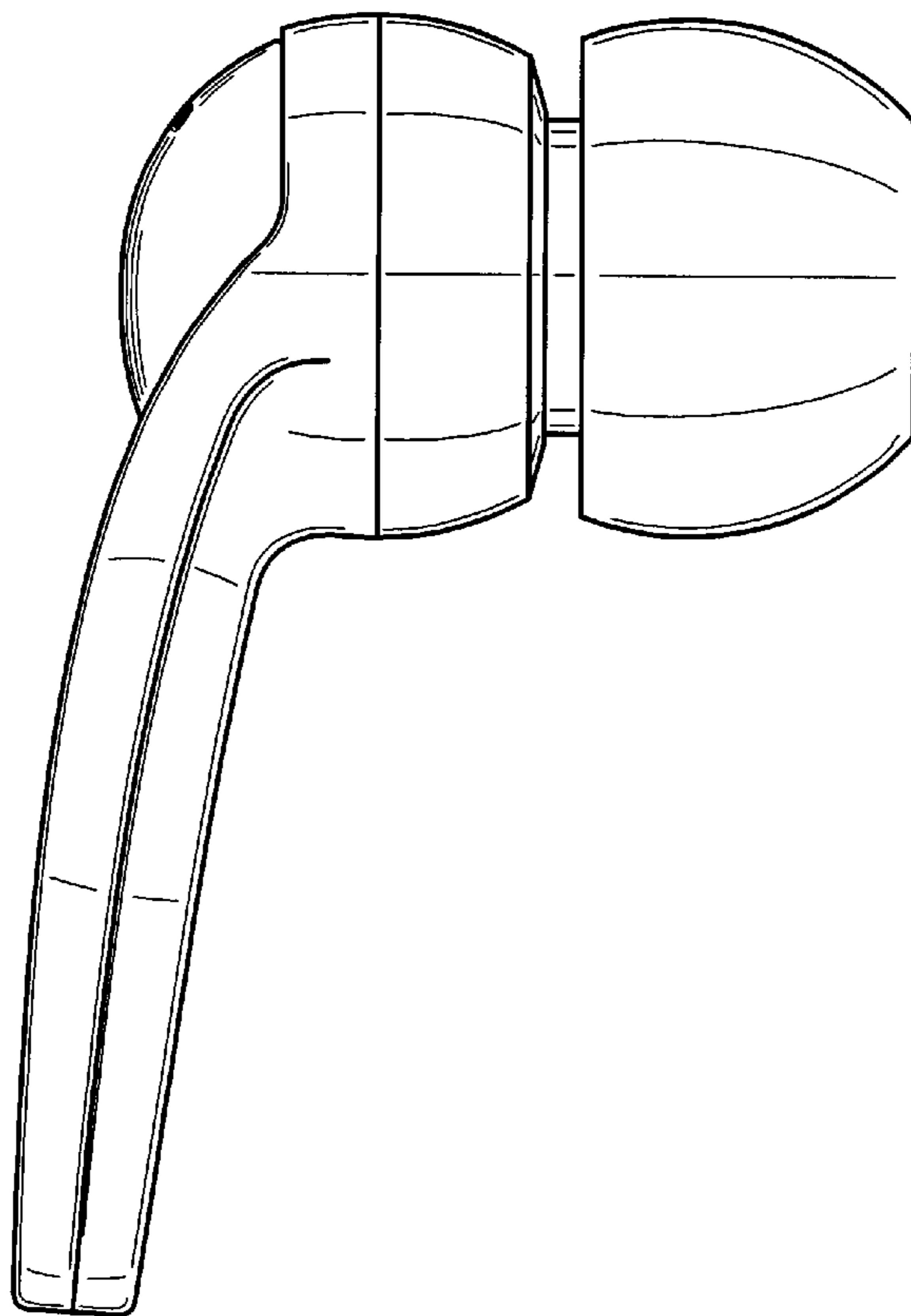


FIG. 5

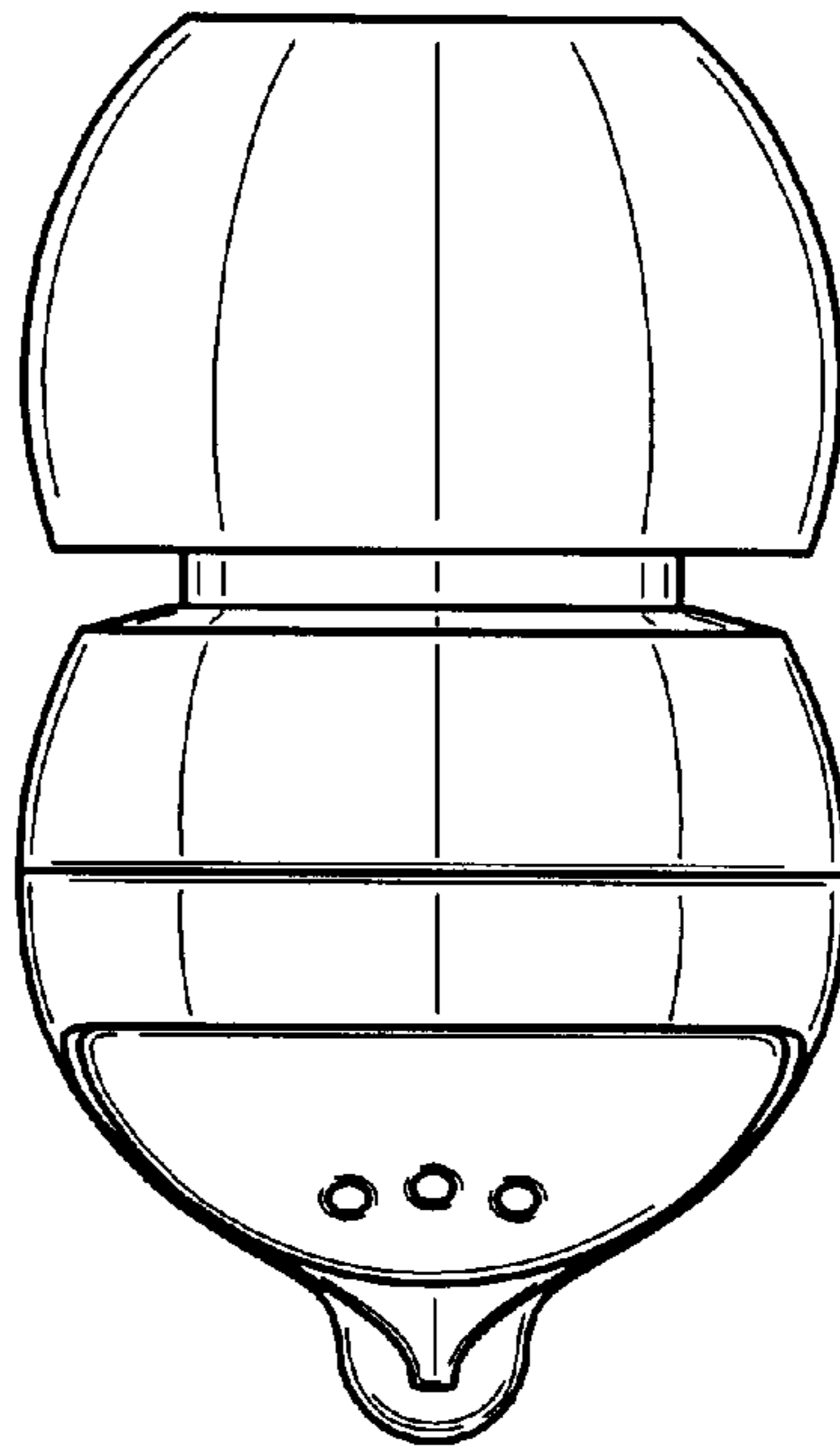


FIG. 6

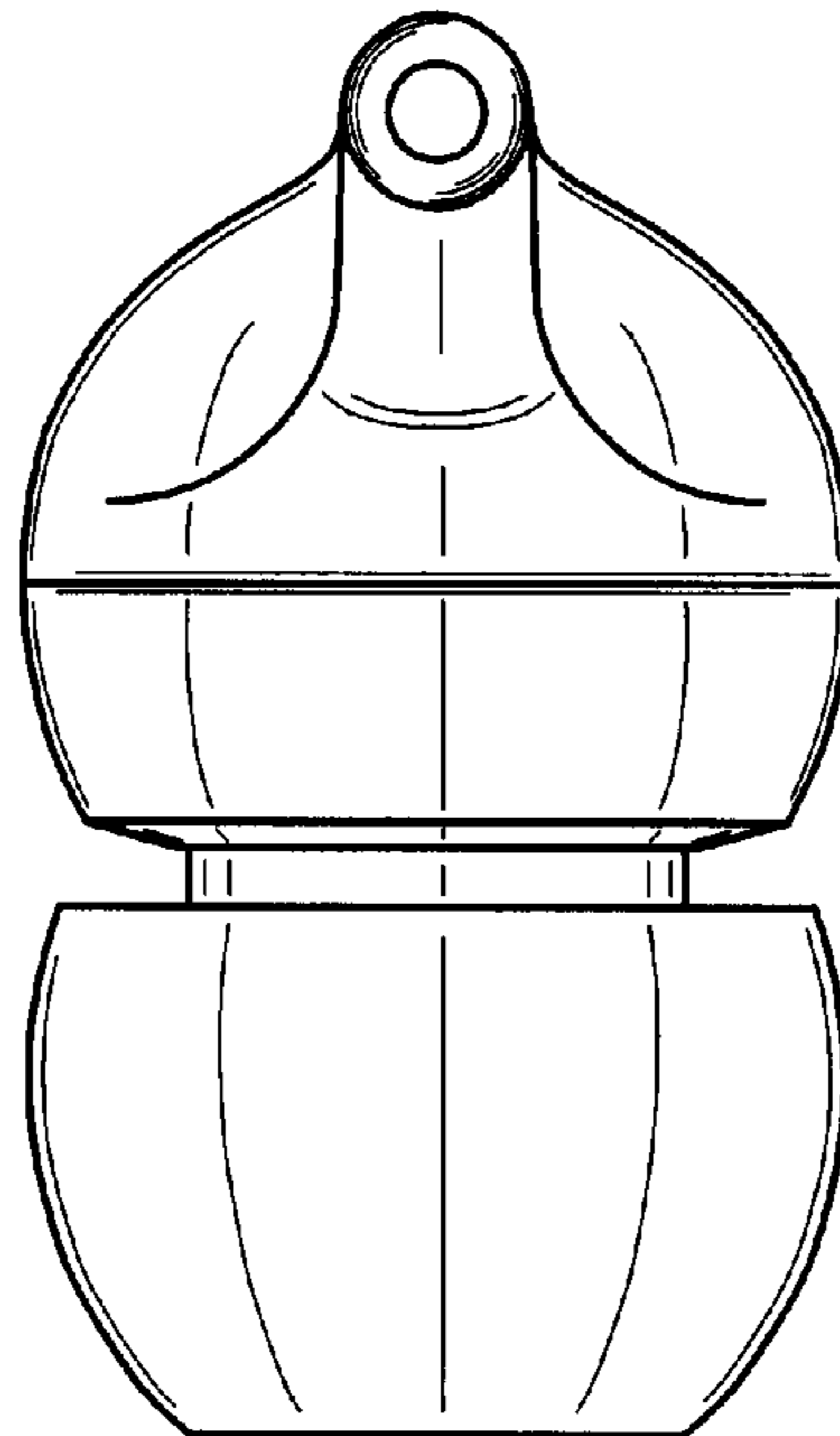


FIG. 7